



Statement of Compliance

Requested Part

25 January 2018

2007194-1

(Part 1 of 1)

SFP+ 1x1 Cage Assembly, PCI, Solder Tail

Part Status: Active

Mil-Spec Certified: No

EU RoHS: Compliant

EU ELV: Compliant

China RoHS:  No Restricted Materials Above Threshold

EU REACH SvHC Compliance: Regulation (EC) No. 1907/2006

Current ECHA Candidate List: **JUL 2017**

Candidate List Declared Against: **JUL 2017**

Does not contain REACH SvHCs

Halogen Content: Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability Code: Reflow solder capable to 260°C

Material Declarations: [MD_2007194-1](#)

TE Connectivity Corporation

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SvHCs in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>